

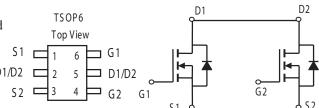
## Dual N-Channel 20-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize High Cell Density process. Low  $r_{DS(on)}$  assures minimal power loss and conserves energy, making this device ideal for use in power management circuitry. Typical applications are DC-DC converters, power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

•	Low DS(on) Provides Higher Efficiency	y and
	Extends Battery Life	

- Low gate charge 7nC
- High performance
- High current handling
- Miniature TSOP-6 Surface Mount Package Saves Board Space

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS (on)</sub> (ohm)	I <sub>D</sub> (A)		
20	0.030	5.0		
20	$0.046 @ V_{GS} = 2.5V$	3.0		



ABSOLUTEM AXIMUM RATINGS (T A = 25 °C UNLES SOTHERWISENOTED)					
Parameter			M aximum	Units	
Drain-Source Voltage			20	V	
Gate-Source Voltage			±10		
Continuous Drain Current <sup>a</sup>	$T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$	I.	3.8		
Continuous Drain Current	$T_A=70^{\circ}C$	ъ	3.0	A	
Pulsed Drain Current <sup>b</sup>		$I_{DM}$	10		
Continuous Source Current (Diode Conduction) <sup>a</sup>			0.46	A	
Decree Disciplation <sup>a</sup>	$T_A=25^{\circ}C$	$P_{\mathrm{D}}$	1.25	$\mid$ W	
Power Dissipation <sup>a</sup>	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	1 D	0.8	VV	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 to 150	°C	

TH ER MALR ESISTANCE RATINGS						
Parameter	Symbol	M aximum	Units			
M · I	t <= 5 sec	D	100	°C/W		
Maximum Junction-to-Ambient <sup>a</sup>	Steady-State	$R_{THJA}$	166			

1

## Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature



SPECIFICATIONS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Conditions	Li mits			Unit	
rarameter	Зуппоог	1 est Conditions	Min	Тур	M ax	Onit	
Static							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \text{ uA}$				V	
Gate-Threshold Voltage	V <sub>G</sub> S(th)	$V_{DS} = V_{GS}, I_D = 250 \text{ uA}$	0.5	0.8	1.5	`	
Gate-Body Leakage	Igss	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$			±100	nA	
Zero Gate Voltage Drain Current	Idss	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA	
Zero Gate Voltage Diam Current	1022	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			10	uA	
On-State Drain Current <sup>A</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			A	
D · C O D · A	IDS(on)	$V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{A}$		27	30	mΩ	
Drain-Source On-Resistance <sup>A</sup>		$V_{GS} = 2.5 \text{ V}, I_{D} = 3.0 \text{ A}$		35	46		
Forward Tranconductance <sup>A</sup>	gs	$V_{DS} = 5 \text{ V}, I_{D} = 3.0 \text{ A}$		11		S	
Diode Forward Voltage	Vsd	$I_S = 2.00 \text{ A}, V_{GS} = 0 \text{ V}$		0.80	1.20	V	
Dynamic <sup>b</sup>	•				•		
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$		11			
Gate-Source Charge	$Q_{gs}$	$I_D = 4.0 \text{ A}$		2.20		пC	
Gate-Drain Charge	Qgd	ID – 4.0 A		2.50			
Switching	•				•		
Turn-On Delay Time	t <sub>d(on)</sub>			9	17		
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, \qquad \text{ID} = 1 \text{ A},$		11	18	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G = 10 \text{ oh,m}$ , $V_{GEN} = 4.5 \text{ V}$		18	29	1115	
Fall-Time	$t_{\mathrm{f}}$			5	10		

- a. Pulse test:  $PW \le 300us duty cycle \le 2\%$ .
- b. Guaranteed by design, not subject to production testing.m

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